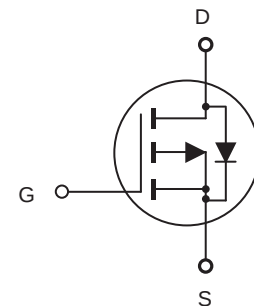


## P-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

### FEATURES

- -60V, -26A,  $R_{DS(ON)} = 42m\Omega$  @  $V_{GS} = -10V$ .  
 $R_{DS(ON)} = 65m\Omega$  @  $V_{GS} = -4.5V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- Lead free product is acquired.
- TO-251 & TO-252 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter                                                                                 | Symbol         | Limit      | Units               |
|-------------------------------------------------------------------------------------------|----------------|------------|---------------------|
| Drain-Source Voltage                                                                      | $V_{DS}$       | -60        | V                   |
| Gate-Source Voltage                                                                       | $V_{GS}$       | $\pm 20$   | V                   |
| Drain Current-Continuous                                                                  | $I_D$          | -26        | A                   |
| Drain Current-Pulsed <sup>a</sup>                                                         | $I_{DM}$       | -104       | A                   |
| Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$<br>- Derate above $25^\circ\text{C}$ | $P_D$          | 50         | W                   |
|                                                                                           |                | 0.4        | W/ $^\circ\text{C}$ |
| Operating and Store Temperature Range                                                     | $T_J, T_{stg}$ | -55 to 150 | $^\circ\text{C}$    |

### Thermal Characteristics

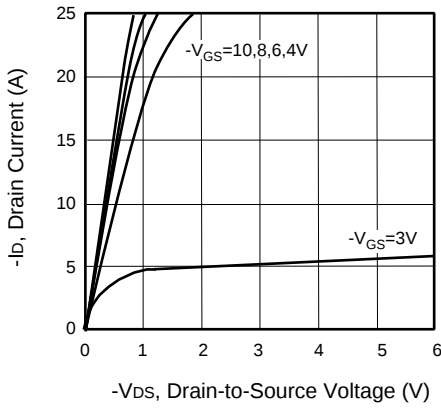
| Parameter                               | Symbol          | Limit | Units              |
|-----------------------------------------|-----------------|-------|--------------------|
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 2.5   | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 50    | $^\circ\text{C/W}$ |



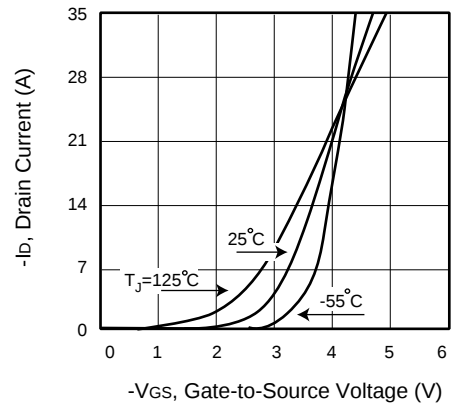
# CED6355/CEU6355

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

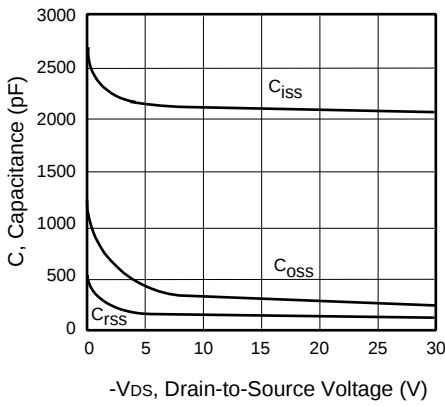
| Parameter                                                                                                                                                                                                                   | Symbol       | Test Condition                                                     | Min | Typ  | Max  | Units     |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|--------------------------------------------------------------------|-----|------|------|-----------|
| Off Characteristics                                                                                                                                                                                                         |              |                                                                    |     |      |      |           |
| Drain-Source Breakdown Voltage                                                                                                                                                                                              | $BV_{DSS}$   | $V_{GS} = 0V, I_D = -250\mu A$                                     | -60 |      |      | V         |
| Zero Gate Voltage Drain Current                                                                                                                                                                                             | $I_{DSS}$    | $V_{DS} = -60V, V_{GS} = 0V$                                       |     |      | -1   | $\mu A$   |
| Gate Body Leakage Current, Forward                                                                                                                                                                                          | $I_{GSSF}$   | $V_{GS} = 20V, V_{DS} = 0V$                                        |     |      | 100  | nA        |
| Gate Body Leakage Current, Reverse                                                                                                                                                                                          | $I_{GSSR}$   | $V_{GS} = -20V, V_{DS} = 0V$                                       |     |      | -100 | nA        |
| On Characteristics <sup>b</sup>                                                                                                                                                                                             |              |                                                                    |     |      |      |           |
| Gate Threshold Voltage                                                                                                                                                                                                      | $V_{GS(th)}$ | $V_{GS} = V_{DS}, I_D = -250\mu A$                                 | -1  |      | -3   | V         |
| Static Drain-Source                                                                                                                                                                                                         | $R_{DS(on)}$ | $V_{GS} = -10V, I_D = -26A$                                        |     | 35   | 42   | $m\Omega$ |
| On-Resistance                                                                                                                                                                                                               |              | $V_{GS} = -4.5V, I_D = -21A$                                       |     | 50   | 65   | $m\Omega$ |
| Dynamic Characteristics <sup>c</sup>                                                                                                                                                                                        |              |                                                                    |     |      |      |           |
| Forward Transconductance                                                                                                                                                                                                    | $g_{FS}$     | $V_{DS} = -10V, I_D = -26A$                                        |     | 22   |      | S         |
| Input Capacitance                                                                                                                                                                                                           | $C_{iss}$    | $V_{DS} = -30V, V_{GS} = 0V,$<br>$f = 1.0\text{ MHz}$              |     | 2020 |      | pF        |
| Output Capacitance                                                                                                                                                                                                          | $C_{oss}$    |                                                                    |     | 180  |      | pF        |
| Reverse Transfer Capacitance                                                                                                                                                                                                | $C_{rss}$    |                                                                    |     | 95   |      | pF        |
| Switching Characteristics <sup>c</sup>                                                                                                                                                                                      |              |                                                                    |     |      |      |           |
| Turn-On Delay Time                                                                                                                                                                                                          | $t_{d(on)}$  | $V_{DD} = -30V, I_D = -20A,$<br>$V_{GS} = -10V, R_{GEN} = 3\Omega$ |     | 15   | 30   | ns        |
| Turn-On Rise Time                                                                                                                                                                                                           | $t_r$        |                                                                    |     | 4    | 8    | ns        |
| Turn-Off Delay Time                                                                                                                                                                                                         | $t_{d(off)}$ |                                                                    |     | 47   | 94   | ns        |
| Turn-Off Fall Time                                                                                                                                                                                                          | $t_f$        |                                                                    |     | 11   | 22   | ns        |
| Total Gate Charge                                                                                                                                                                                                           | $Q_g$        | $V_{DS} = -30V, I_D = -20A,$<br>$V_{GS} = -10V$                    |     | 32.2 | 42.8 | nC        |
| Gate-Source Charge                                                                                                                                                                                                          | $Q_{gs}$     |                                                                    |     | 5.7  |      | nC        |
| Gate-Drain Charge                                                                                                                                                                                                           | $Q_{gd}$     |                                                                    |     | 5.4  |      | nC        |
| Drain-Source Diode Characteristics and Maximun Ratings                                                                                                                                                                      |              |                                                                    |     |      |      |           |
| Drain-Source Diode Forward Current                                                                                                                                                                                          | $I_S$        |                                                                    |     |      | -26  | A         |
| Drain-Source Diode Forward Voltage <sup>b</sup>                                                                                                                                                                             | $V_{SD}$     | $V_{GS} = 0V, I_S = -26A$                                          |     |      | -1.3 | V         |
| Notes :<br>a.Repetitive Rating : Pulse width limited by maximum junction temperature.<br>b.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .<br>c.Guaranteed by design, not subject to production testing. |              |                                                                    |     |      |      |           |



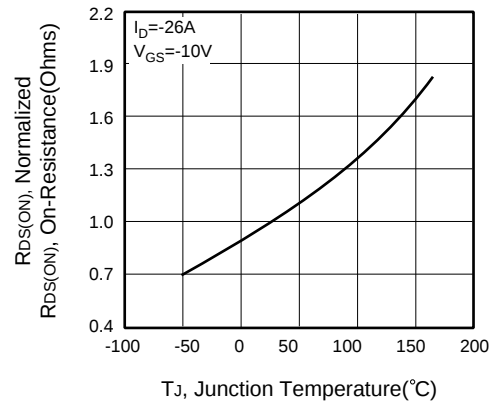
**Figure 1. Output Characteristics**



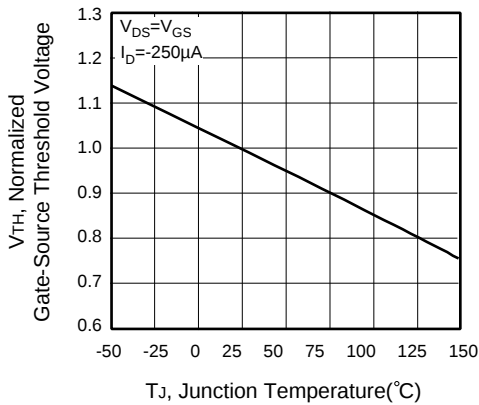
**Figure 2. Transfer Characteristics**



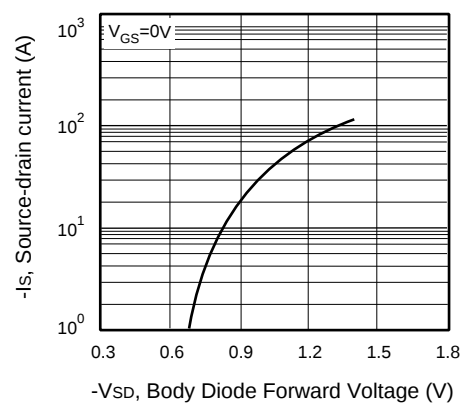
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

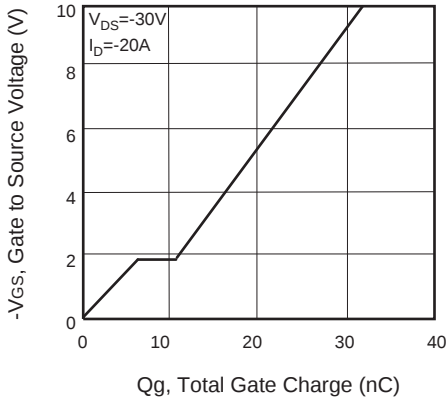


Figure 7. Gate Charge

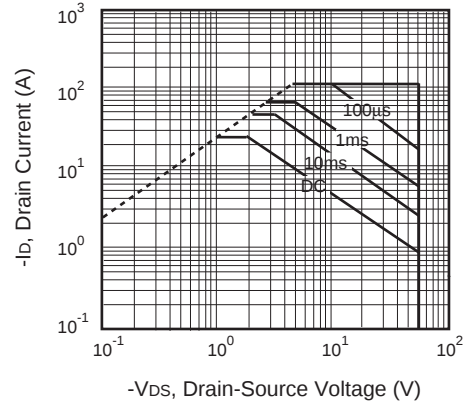


Figure 8. Maximum Safe Operating Area

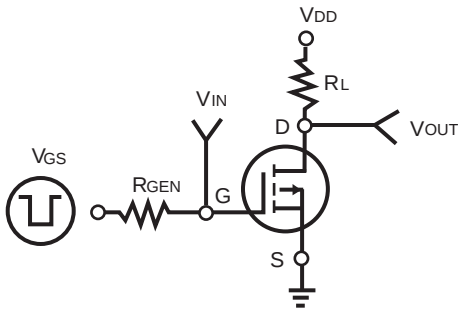


Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

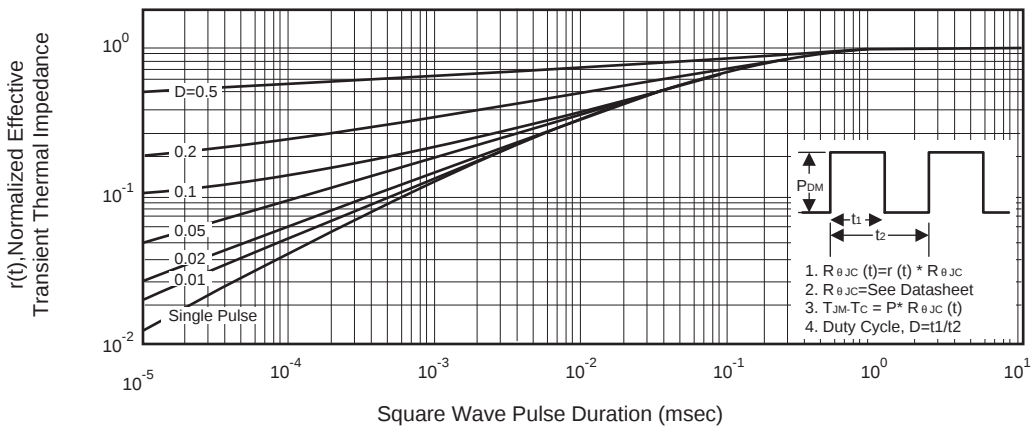


Figure 11. Normalized Thermal Transient Impedance Curve